

BL081

5-4000 MHz Wideband Low Noise Amplifier



Device Features

- NF = 0.95 dB @ 900MHz at RF connectors of Demo board
- Gain = 20.5 dB @ 900 MHz
- OIP3 = 30.0 dBm @ 1900MHz
- Output P1 dB = 17.5 dBm @ 900MHz
- 5V/27mA, MTTF > 100 Years, MSL 1, Class 0
- Lead-free/RoHS-compliant SOT-89 SMT package



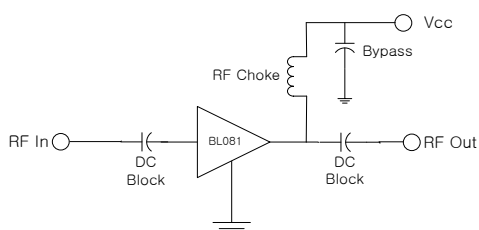
Product Description

BeRex's BL081 is a high performance LNA based on GaAs material with E-pHEMT process, packaged in a RoHS-compliant with SOT-89 surface mount package. It is designed for use where low noise and high linearity are required and features low noise and high OIP3 with **low current** at wideband frequency. It requires a few external matching components. All devices are 100% RF/DC tested and classified as HBM ESDS **Class 0**.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Applications Circuit



*external matching circuit: refer to the page 4 to 12.

Typical Performance¹

Parameter	Frequency					Unit
	900	1900	2140	2450	3500	
Gain	20.5	17.0	16.0	15.5	13.4	dB
S11	-20.0	-20.0	-20.0	-21.0	-18.3	dB
S22	-22.0	-17.0	-17.0	-17.0	-12.1	dB
OIP3 ²	28.5	30.0	30.0	30.0	31.1	dBm
P1dB	17.5	17.5	17.5	17.5	18.5	dBm
Noise Figure	0.95	1.13	1.15	1.25	1.4	dB

¹ Device performance _ measured on a BeRex evaluation board at 25°C, 50 Ω system.

² OIP3 _ measured with two tones at an output of 5 dBm per tone separated by 1 MHz.

	Min.	Typical	Max.	Unit
Bandwidth	5		4000	MHz
I _C @ (V _C = 5V)	15	27	35	mA
V _C		5.0		V
R _{TH}		63		°C/W

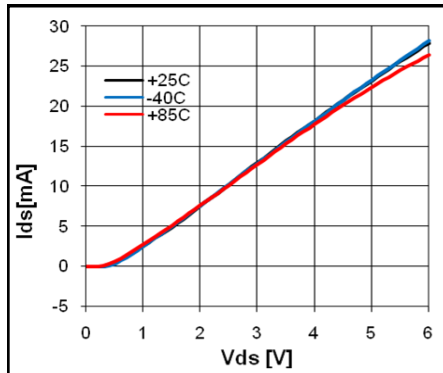
Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+6.0	V
Supply Current	160	mA
Input RF Power	30	dBm

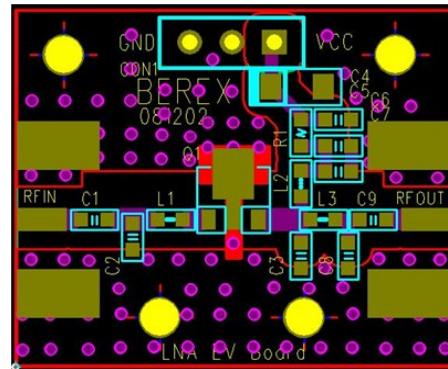
Operation of this device above any of these parameters may result in permanent damage.



V-I Characteristics



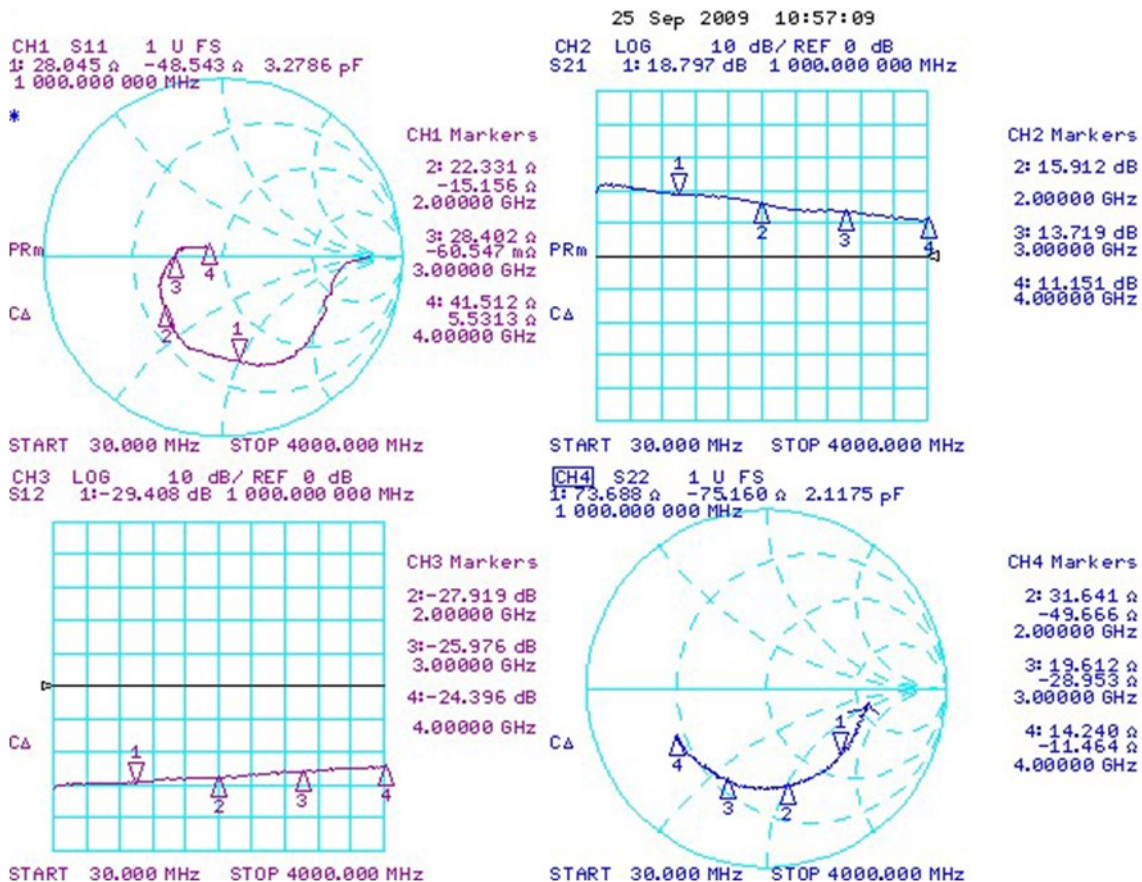
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

S-parameters ($V_d=5V$, $I_d=25mA$, $T=25^\circ C$)





S-Parameter

(V_{device} = 5.0V, I_{cc} = 25mA, T = 25 °C, calibrated to device leads)

Freq [MHz]	S11 [Mag]	S11 [Ang]	S21 [Mag]	S21 [Ang]	S12 [Mag]	S12 [Ang]	S22 [Mag]	S22 [Ang]
100	0.637	-10.630	12.304	172.181	0.032	12.944	0.569	-8.574
500	0.678	-53.138	10.733	148.743	0.033	10.572	0.558	-21.318
1000	0.589	-82.755	8.815	126.435	0.035	17.891	0.554	-41.116
1500	0.513	-117.379	7.781	105.710	0.039	22.555	0.553	-60.200
2000	0.429	-139.689	6.261	82.420	0.041	23.205	0.555	-78.933
2500	0.371	-160.253	4.886	74.655	0.046	29.503	0.563	-96.918
3000	0.280	179.851	4.870	63.131	0.051	27.793	0.558	-114.110
3500	0.205	164.524	4.016	47.709	0.056	27.902	0.554	-133.482
4000	0.107	144.464	3.553	41.113	0.061	27.767	0.567	-153.176

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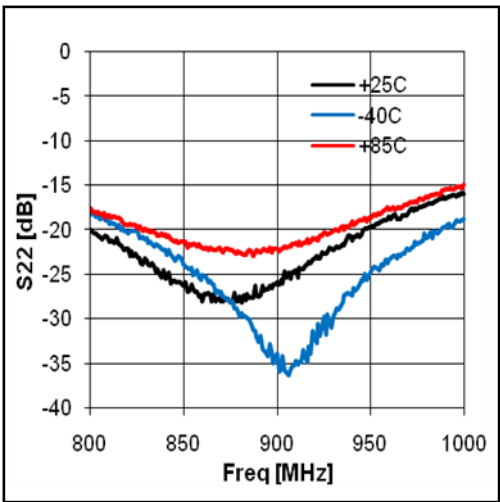
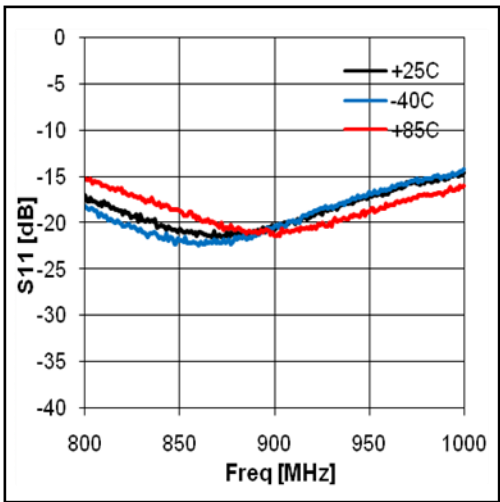
5-4000 MHz Wideband Low Noise Amplifier



Application Circuit: 900 MHz

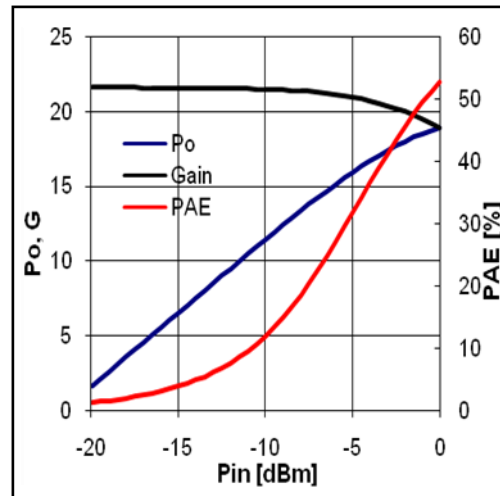
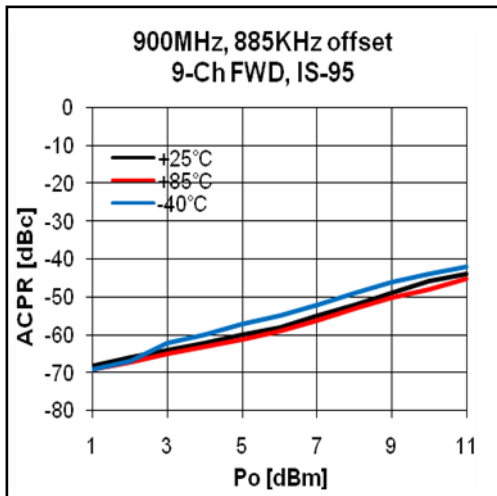
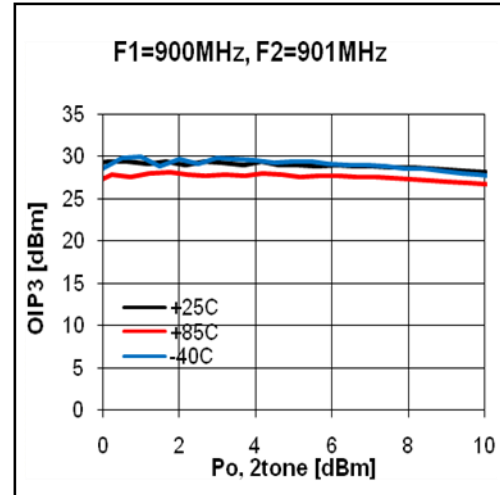
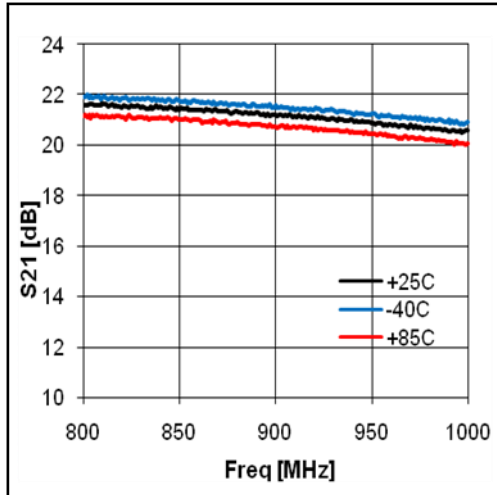
Schematic Diagram	BOM		Tolerance
	C1	10uF	± 20%
	C2	1nF	± 5%
	C3	100pF	±5%
	C4	100pF	±5%
	C5	100pF	±5%
	C6	0.5pF	± 5%
	L1	100nH	±5%
	L2	8.2nH	±5%
	L3	10nH	±5%

Typical Performance



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Noise Figure Temperature Performance

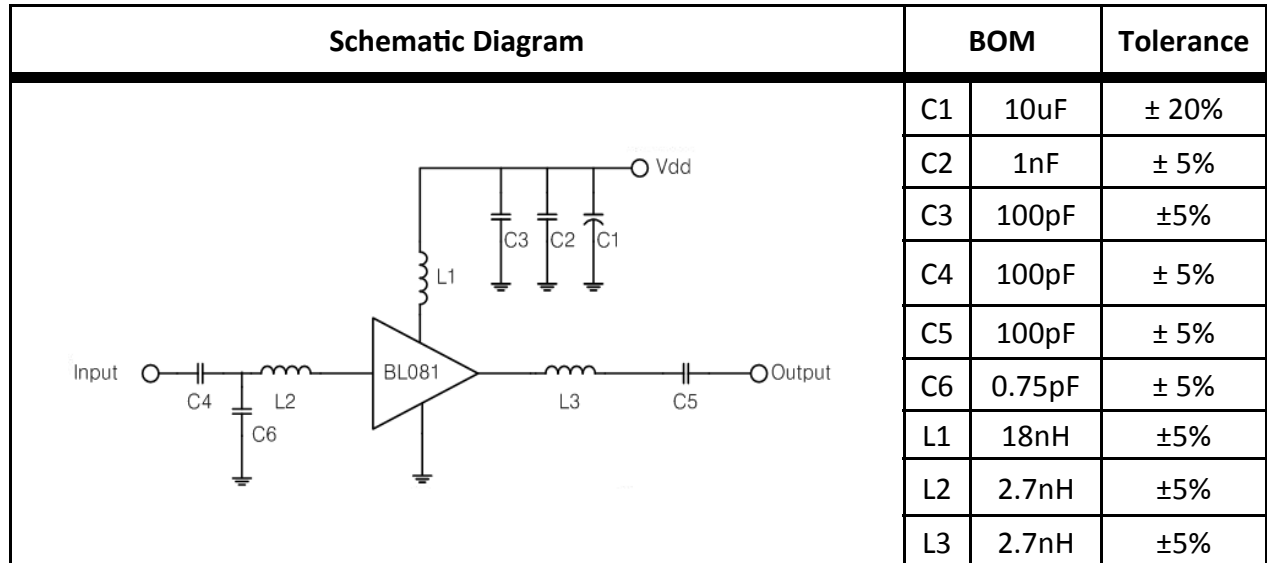
(V_{ds} = 5.0V, I_{ds} = 25.0mA)

Freq	MHz	900	1900	2140	2450
Temp [°C]	-40	0.78	0.96	0.98	0.92
	25	0.98	1.25	1.18	1.16
	85	1.12	1.45	1.48	1.45

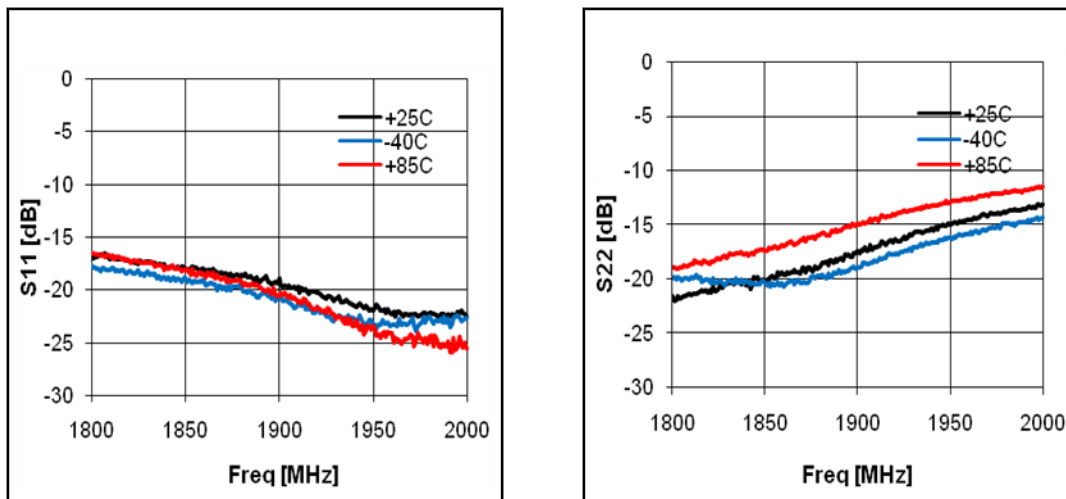
5-4000 MHz Wideband Low Noise Amplifier



Application Circuit: 1900 MHz

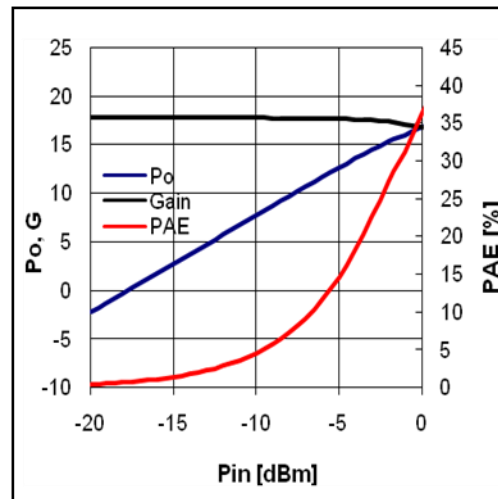
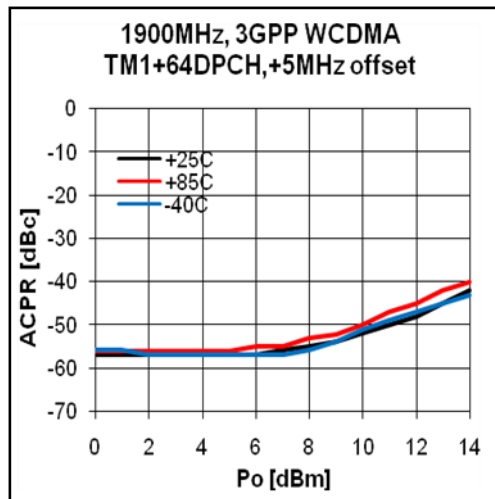
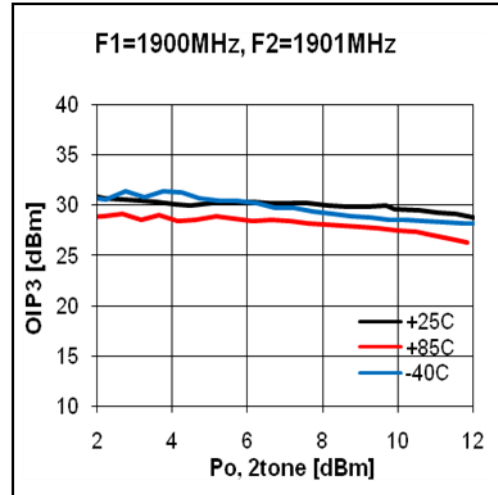
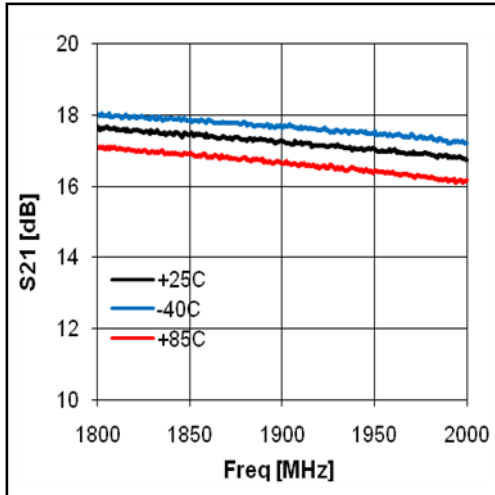


Typical Performance



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Noise Figure Temperature Performance

(V_{ds} = 5.0V, I_{ds} = 25.0mA)

Freq	MHz	900	1900	2140	2450
Temp [°C]	-40	0.78	0.96	0.98	0.92
	25	0.98	1.25	1.18	1.16
	85	1.12	1.45	1.48	1.45

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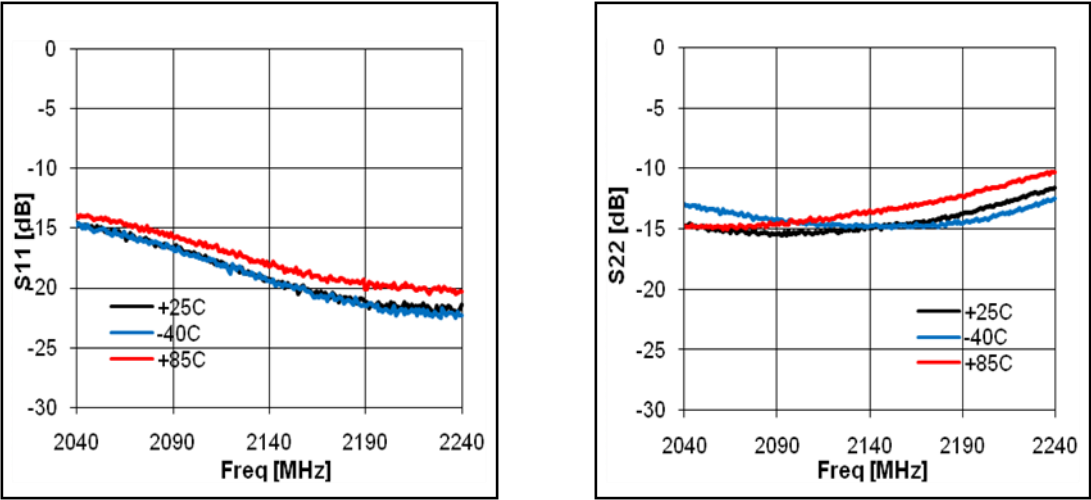
5-4000 MHz Wideband Low Noise Amplifier

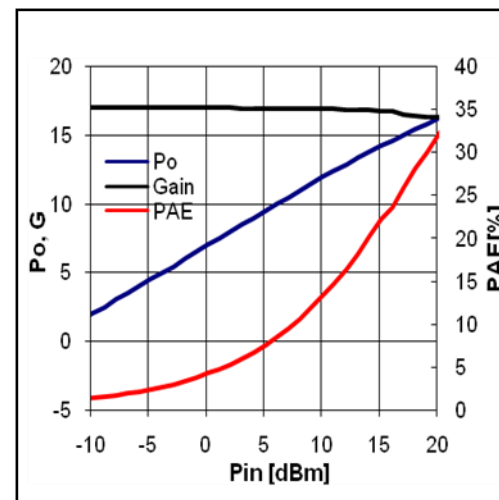
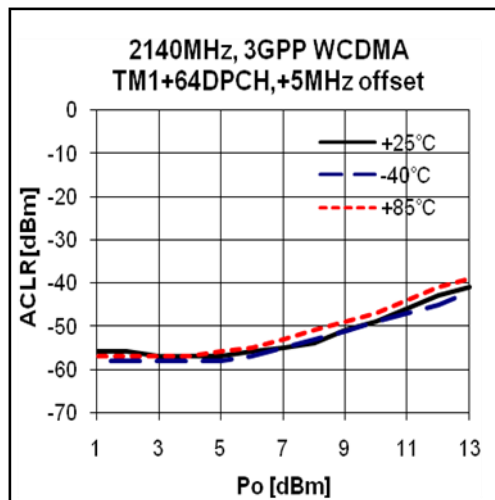
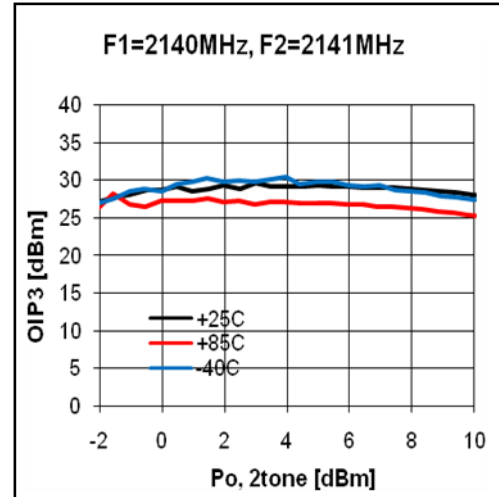
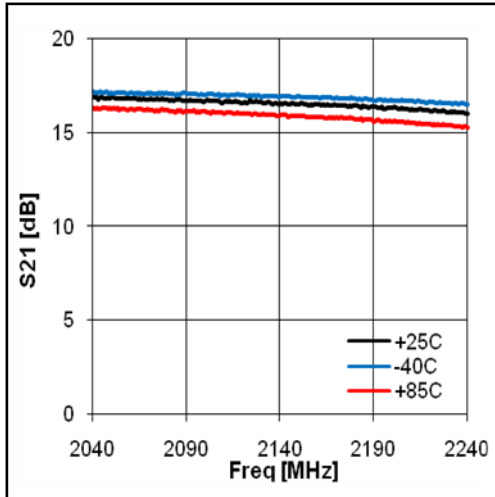


Application Circuit: 2140 MHz

Schematic Diagram	BOM		Tolerance
	C1	10uF	± 20%
	C2	1000pF	± 5%
	C3	100pF	±5%
	C4	18pF	± 5%
	C5	18pF	± 5%
	C6	0.75pF	± 5%
	C7	0.5pF	±5%
	L1	33nH	±5%
	L2	1.5nH	±5%
	L3	4.7nH	±5%

Typical Performance





Noise Figure Temperature Performance

(V_{ds} = 5.0V, I_{ds} = 25.0mA)

Freq	MHz	900	1900	2140	2450
Temp [°C]	-40	0.78	0.96	0.98	0.92
	25	0.98	1.25	1.18	1.16
	85	1.12	1.45	1.48	1.45

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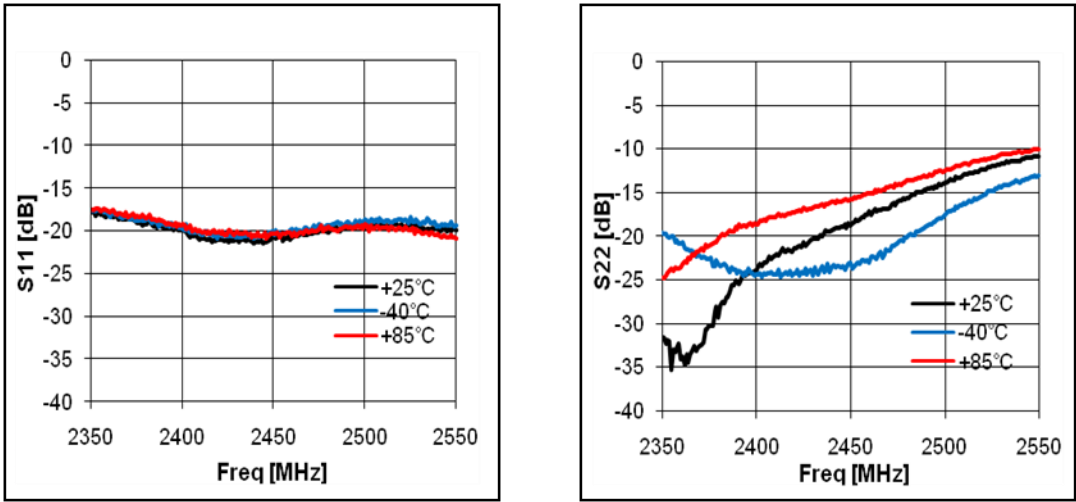
5-4000 MHz Wideband Low Noise Amplifier



Application Circuit: 2450 MHz

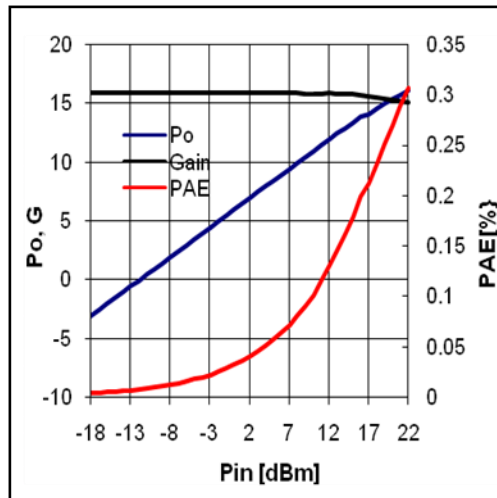
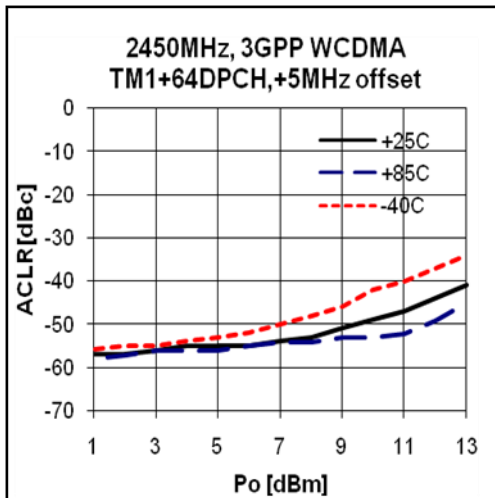
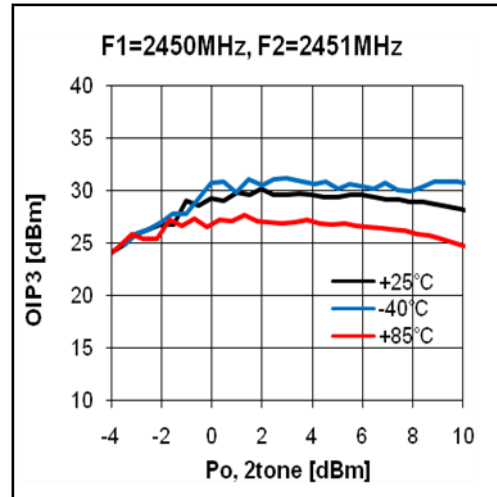
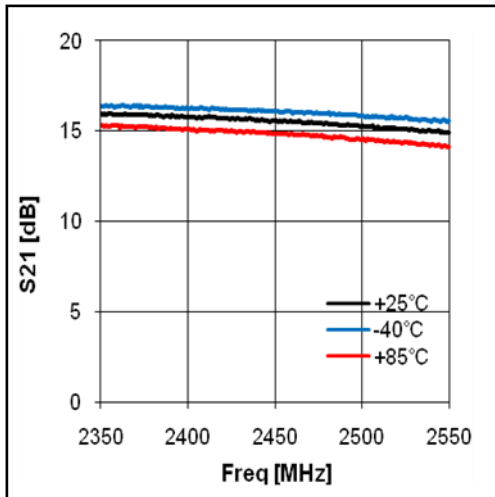
Schematic Diagram	BOM		Tolerance
	C1	10uF	± 20%
	C2	1000pF	± 5%
	C3	100pF	±5%
	C4	22pF	± 5%
	C5	22pF	± 5%
	C6	0.5pF	± 5%
	C7	1pF	±5%
	L1	47nH	±5%
	L2	1.8nH	±5%
	L3	3.9nH	±5%

Typical Performance



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Noise Figure Temperature Performance

(V_{ds} = 5.0V, I_{ds} = 25.0mA)

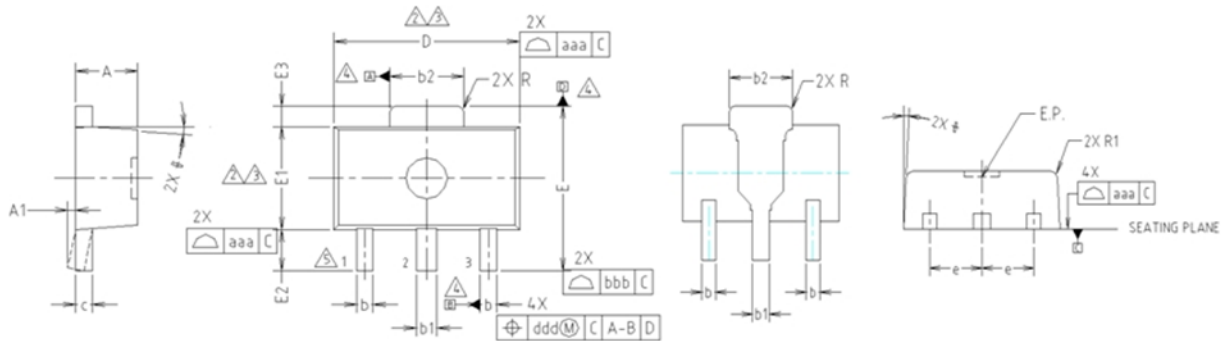
Freq	MHz	900	1900	2140	2450
Temp [°C]	-40	0.78	0.96	0.98	0.92
	25	0.98	1.25	1.18	1.16
	85	1.12	1.45	1.48	1.45

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Package Outline Dimension



NOTE:

1. DIMENSIONS IN MILLIMETERS.

⚠ DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5mm PER SIDE.

⚠ DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

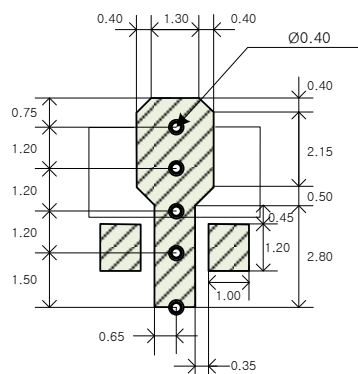
⚠ DATUMS A, B AND D TO BE DETERMINED 0.18mm FROM THE LEAD TIP.

⚠ TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	1.40	1.50	1.60	
A1	0.00	—	0.10	
b	0.38	0.42	0.48	
b1	0.48	0.52	0.58	
b2	1.79	1.82	1.87	
c	0.40	0.42	0.46	
D	4.40	4.50	4.70	2,3
E	3.70	4.00	4.30	
E1	2.40	2.50	2.70	2,3
E2	0.80	1.00	1.20	
E3	0.40	0.50	0.60	
e	1.50 TYP.			
φ	4° TYP.			
R	0.15 TYP.			
R1	—	—	0.20	
SYMBOL	TOLERANCES OF FORM AND POSITION		NOTE	
	aaa	bbb		
aaa	0.15			
bbb	0.20			
ccc	0.10			
ddd	0.10			

Suggested PCB Land Pattern and PAD Layout

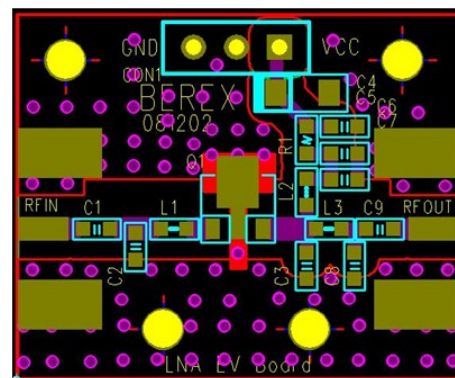
PCB Land Pattern



Note : All dimension _ millimeters

PCB lay out _ on BeRex website

PCB Mounting

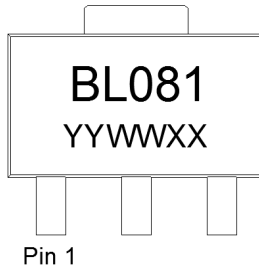


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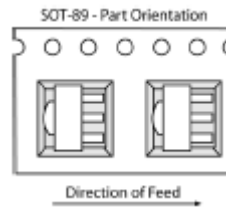
Package Marking



YY = Year, WW = Working Week,
XX = Wafer No.

Tape & Reel

SOT89



Packaging information:

Tape Width (mm): 12
Reel Size (inches): 7
Device Cavity Pitch (mm): 8
Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating:	Class 0
Value:	Passes <200V
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114B
MSL Rating:	Level 1 at +265°C convection reflow
Standard:	JEDEC Standard J-STD-020

NATO CAGE code:

2	N	9	6	F
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